# 505801494 12/03/2019

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5848323

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
KARL GEORG HAMPEL	11/12/2019
NAVID ABEDINI	11/12/2019
MUHAMMAD NAZMUL ISLAM	11/12/2019
JIANGHONG LUO	11/12/2019
JUNYI LEE	11/14/2019
TAO LUO	11/18/2019
HONG CHENG	11/12/2019

## **RECEIVING PARTY DATA**

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

## **PROPERTY NUMBERS Total: 2**

Property Type	Number
Application Number:	16572219
Application Number:	62734947

### **CORRESPONDENCE DATA**

**Fax Number:** (303)473-2720

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 3034732700

**Email:** plnorman@hollandhart.com

Correspondent Name: MICHAEL DRAPKIN Address Line 1: P.O. BOX 11583

Address Line 4: SALT LAKE CITY, UTAH 84147

ATTORNEY DOCKET NUMBER:	PR104.01 (103038.0526)
NAME OF SUBMITTER:	MICHAEL L. DRAPKIN
SIGNATURE:	/Michael L. Drapkin/

PATENT 505801494 REEL: 051167 FRAME: 0532

DATE SIGNED:	12/03/2019
Total Attachments: 9	
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#### ASSIGNMENT

## WHEREAS, WE,

- 1. Karl Georg HAMPEL, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
- 2. Navid ABEDINI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714.
- 3. Muhammad Nazmul ISLAM, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
- 4. Jianghong LUO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714.
- 5. Junyi LI, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714,
- 6. Tao LUO, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714.
- 7. Hong CHENG, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **RELAY NODES WITH MULTI-CONNECTED CELLULAR BACKHAUL** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that I/WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/572,219 filed September 16, 2019,

Qualcomm Reference No. 185133, and all provisional applications relating thereto, together with U.S. Provisional Application No. 62/734,947 filed September 21, 2018, Qualcomm Reference No. 185133P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

# PATENT

QUALLOMM Ref. No. 185133 Page 3 of 3

AN whatsoever	D WE HEREBY cover conflicting with these pa	uant that WE will resents.	I not execute any writing or do any act
	LOCATION		Karl Georg NAMPEL
	NJ <u>Mendere</u> , on //: LOCATION		
Done at	LOCATION On	DATE	Muhammad Nazmul ISLAM
Done at S	A) JT <u>1 december</u> on <u>11</u> LOCATION	- <u>  2 - 20</u> 19 DATE	Jianghong LUO
Done at Z	NJ <u>ideewster</u> , on <u>//</u> LOCATION	- <u>/4 - 20 /</u> 9 Date	Junyi Li
Done at	LOCATION OR	DATE	Tao LUO
Done at S	AJJ <u>Macwater</u> , on <u>11</u> LOCATION	<u>-(2-201</u> 9 DATE	CARLON CHENG

#### ASSIGNMENT

## WHEREAS, WE,

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- 7. Hong CHENG, having a mailing address located at 5775 Morehouse Drive, San Diego, CA, 92121-1714.

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WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that I/WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 16/572,219 filed September 16, 2019,

Qualcomm Reference No. 185133, and all provisional applications relating thereto, together with U.S. Provisional Application No. 62/734,947 filed September 21, 2018, Qualcomm Reference No. 185133P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

# PATENT QUALCOMM Ref. No. 185133 Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, 00		
	LOCATION . on	DATE	Karl Georg HAMPEL
Done at	, 03	DATE	
	LOCATION	DATE	Navid ABEDINI
Done at <sup>©</sup>	WAROROVA MA	V/12/2019	——————————————————————————————————————
2000	LOCATION	DATE	Muhammad Nazmul ISLAM
Done at	\$00 p		
	LOCATION OIL	DATE	Jianghong LUO
Done at	.00.		
	LOCATION	DATE	Junyi L.I
Done at	, 6n		
	LOCATION	DATE	Tae LUQ
Done at	.00		
and the second second	LOCATION	DATE	Hong CHENG

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PATENT QUALCOMM Ref. No. 185133 Page 3 of 3

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Done at	, OÑ		***************************************
	LOCATION	DATE	Karl Georg HAMPEL
Done at	* 00		
	LOCATION	DATE	Navid ABEDINI
Done at	LOCATION	·······	
	LOCATION	DATE	Muhammad Nazmul ISLAN
Done at _	LOCATION		
	LOCATION	DATE	Jianghong LUO
Done at	,00	·····	
	LOCATION	DATE	Junyi LI
Done at	2/2/2/25.00 i	<u>U/8/24</u> 7 :	
	LOCÁTION	(Date /	Tao LUO
Done at			
	LOCATION	DATE	Hong CHENG

PATENT REEL: 051167 FRAME: 0542

**RECORDED: 12/03/2019**